



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Micro Chip Fuse

Type: **ERBRD**
ERBRE
ERBRG



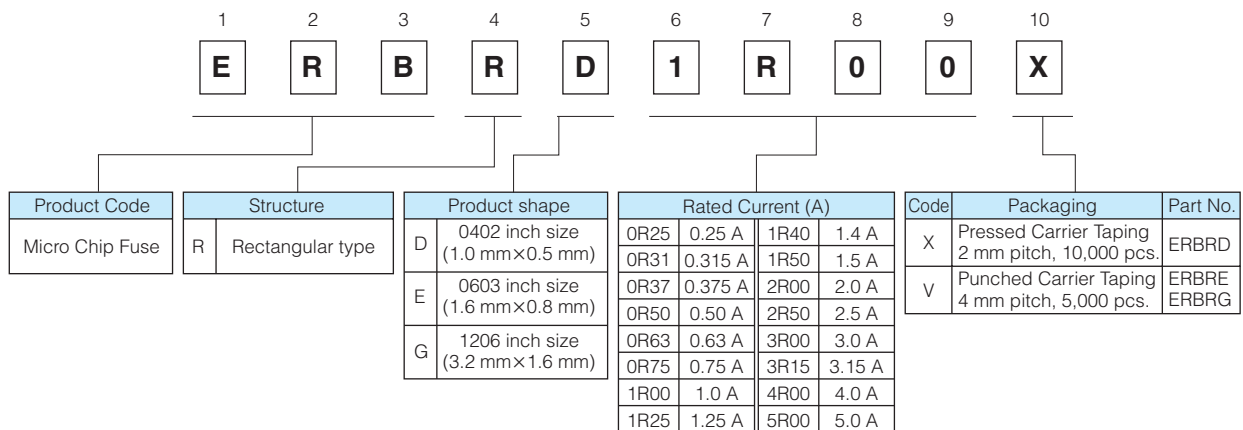
Features

- Small size
- Fast-acting and withstanding in-rush current characteristics
- RoHS compliant

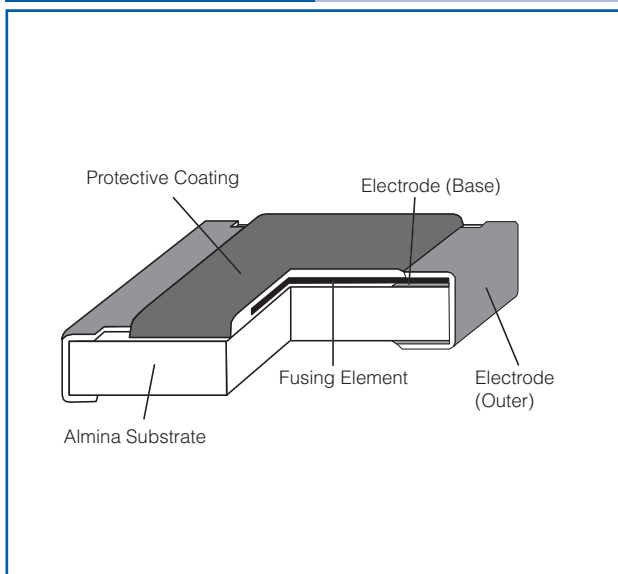
Approved Safety Standards

UL248-14 : File No.E194052
c-UL C22.2 No.248-14 : File No.E194052

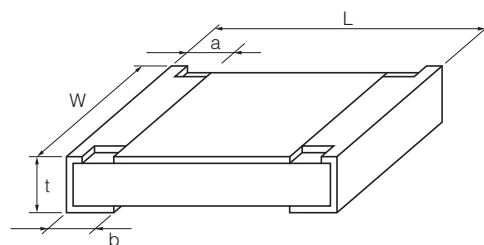
Explanation of Part Numbers



Construction



Dimensions in mm (not to scale)



Part No. (inch size)	Dimensions (mm)					Mass (Weight) (g/1000 pcs.)
	L	W	a	b	t	
ERBRD (0402)	1.00 ^{+0.10}	0.50 ^{+0.10} _{-0.05}	0.15 ^{+0.10}	0.25 ^{+0.10}	0.39 ^{+0.10}	0.7
ERBRE (0603)	1.60 ^{+0.15}	0.80 ^{+0.15} _{-0.05}	0.24 ^{+0.15}	0.30 ^{+0.15}	0.54 ^{+0.10}	2.2
ERBRG (1206)	3.20 ^{+0.20}	1.60 ^{+0.15}	0.30 ^{+0.20}	0.55 ^{+0.20}	0.65 ^{+0.10}	10

Ratings

- 0402 inch /1005 mm size : Type ERBRD

Part No.	ERBRD□R□□X													
	0R25	0R31	0R37	0R50	0R63	0R75	1R00	1R25	1R50	2R00	2R50	3R00	4R00	5R00
Rated Current (A)	0.25	0.315	0.375	0.5	0.63	0.75	1.0	1.25	1.5	2.0	2.5	3.0	4.0	5.0
Marking Code	V	X	Y	F	6	G	H	J	K	N	O	P	S	T
Internal R (mΩ) at 25 °C max.	700	520	440	310	220	190	125	82	70	53	42	37	24	19.5
Fusing Current/Fusing Time (at 25 °C)	Rated Current × 100 % / 4 hours min.													
	Rated Current × 200 % / 5 seconds max.													
	Rated Current × 300 % / 0.2 seconds max.													
Rated Voltage (Open Circuit Voltage)	32 VDC													
Interrupting Rating (at Rated Voltage)	35 A													
Category Temp. Range	-40 °C to +125 °C													

- 0603 inch / 1608 mm size : Type ERBRE

Part No.	ERBRE□R□□V											
	0R50	0R75	1R00	1R25	1R40	1R50	2R00	2R50	3R00	3R15	4R00	5R00
Rated Current (A)	0.5	0.75	1.0	1.25	1.4	1.5	2.0	2.5	3.0	3.15	4.0	5.0
Marking Code	F	G	H	J	14	K	N	O	P	31	S	T
Internal R (mΩ) at 25 °C max.	330	190	125	94	85	72	51	40	33	32	22	19
Fusing Current/Fusing Time (at 25 °C)	Rated Current × 100 % / 4 hours min.											
	Rated Current × 200 % / 5 seconds max.											
	Rated Current × 300 % / 0.2 seconds max.											
Rated Voltage (Open Circuit Voltage)	32 VDC											
Interrupting Rating (at Rated Voltage)	50 A											
Category Temp. Range	-40 °C to +125 °C											

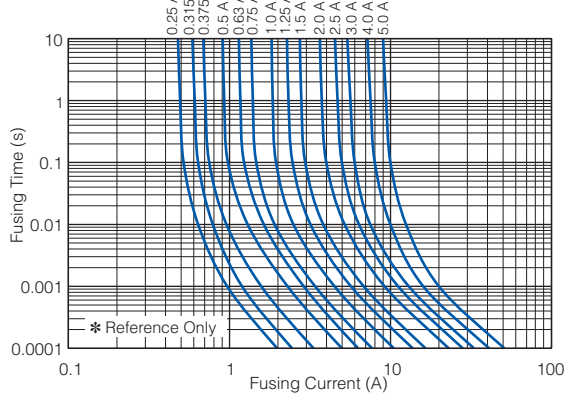
- 1206 inch / 3216 mm size : Type ERBRG

Part No.	ERBRG□R□□V									
	0R50	0R75	1R00	1R25	1R50	2R00	2R50	3R00	4R00	
Rated Current (A)	0.5	0.75	1.0	1.25	1.5	2.0	2.5	3.0	4.0	
Marking Code	F	G	H	J	K	N	O	P	S	
Internal R (mΩ) at 25 °C max.	560	340	210	175	115	85	65	45	35	
Fusing Current/Fusing Time (at 25 °C)	Rated Current × 100 % / 4 hours min.									
	Rated Current × 200 % / 5 seconds max.									
	Rated Current × 300 % / 0.2 seconds max.									
Rated Voltage (Open Circuit Voltage)	63 VDC					32 VDC				
Interrupting Rating (at Rated Voltage)	50 A									
Category Temp. Range	-40 °C to +125 °C									

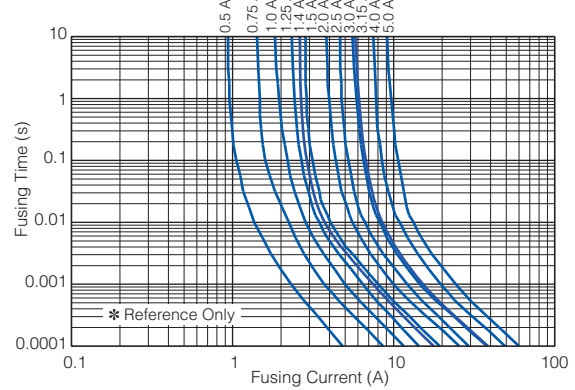
- * The thin type is available about 1005 (0402 inch) size. Please contact us for details.
- * Please contact us when another rated current is needed.

Fusing Characteristics (25 °C typical)

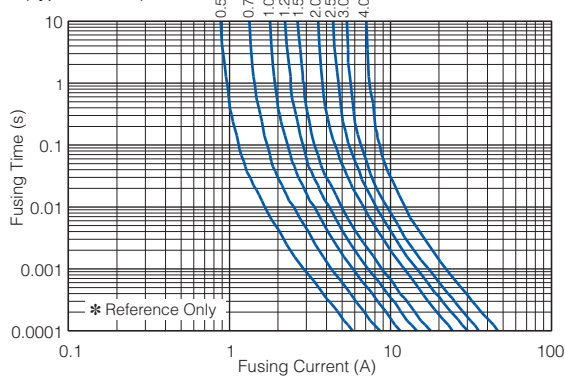
● 0402 inch / 1005 mm size
(Type ERBRD)



● 0603 inch / 1608 mm size
(Type ERBRE)



● 1206 inch / 3216 mm size
(Type ERBRG)



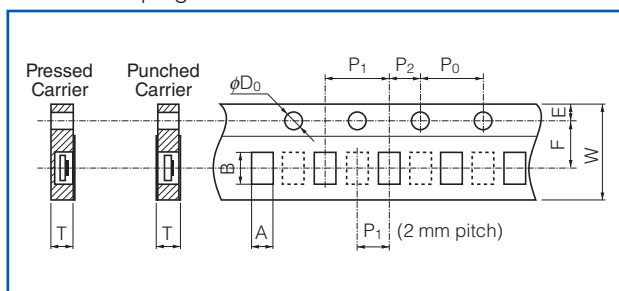
Packaging Methods

● Standard Quantity

Part No.	inch size	Kind of Taping	Pitch (P ₁)	Quantity
ERBRD	0402	Pressed Carrier Taping	2 mm	10,000 pcs./ reel
ERBRE	0603	Punched Carrier Taping	4 mm	5,000 pcs./ reel
ERBRG	1206			

● Carrier Taping

(Unit : mm)

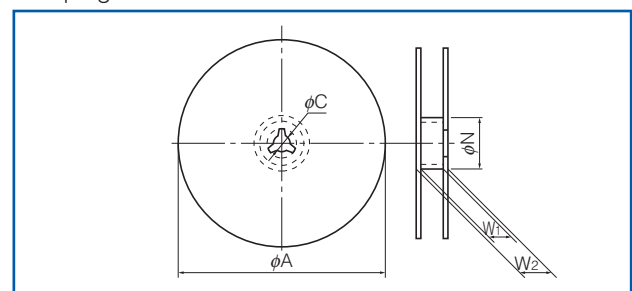


Part No.	A	B	W	F	E
ERBRD	0.68 ^{±0.10}	1.20 ^{±0.10}	8.00 ^{±0.20}	3.50 ^{±0.05}	1.75 ^{±0.10}
ERBRE	1.10 ^{±0.10}	1.90 ^{±0.10}			
ERBRG	2.00 ^{±0.15}	3.60 ^{±0.20}			

Part No.	P ₁	P ₂	P ₀	φD ₀	T
ERBRD	2.00 ^{±0.10}	2.00 ^{±0.05}	4.00 ^{±0.10}	1.50 ^{+0.10} ₀	0.67 ^{±0.07}
ERBRE	4.00 ^{±0.10}				0.78 ^{±0.07}
ERBRG					0.84 ^{±0.07}

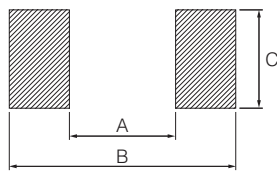
● Taping Reel

(Unit : mm)



Part No.	φA	φN	φC	W ₁	W ₂
ERBRD ERBRE ERBRG	180.0 ⁰ _{-1.5}	60 ^{+1.0} ₀	13.0 ^{±0.2}	9.0 ^{+1.0} ₀	11.4 ^{±1.0}

Recommended Soldering Conditions

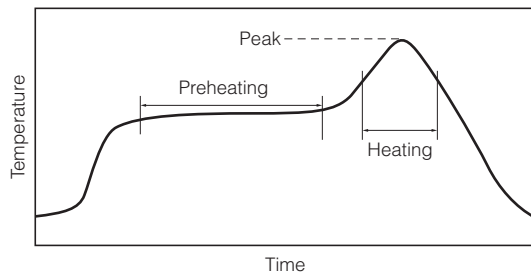


Part No. (inch size)	Dimensions (mm)		
	A	B	C
ERBRD(0402)	0.5 to 0.6	1.4 to 1.6	0.4 to 0.6
ERBRE(0603)	0.7 to 0.9	2.0 to 2.2	0.8 to 1.0
ERBRG(1206)	2.0 to 2.4	4.4 to 5.0	1.2 to 1.8

Recommended Soldering Conditions

Recommendations and precautions are described below.

- Recommended soldering conditions for reflow
 - Reflow soldering shall be performed a maximum of two times.
 - Please contact us for additional information when used in conditions other than those specified.
 - Please measure the temperature of the terminals and study every kind of solder and printed circuit board for solderability before actual use.



For soldering (Example : Sn/Pb)

	Temperature	Time
Preheating	140 °C to 160 °C	60 s to 120 s
Main heating	Above 200 °C	30 s to 40 s
Peak	235 ± 5 °C	max. 10 s

For lead-free soldering (Example : Sn/Ag/Cu)

	Temperature	Time
Preheating	150 °C to 180 °C	60 s to 120 s
Main heating	Above 230 °C	30 s to 40 s
Peak	max. 260 °C	max. 10 s

- Recommended soldering conditions for flow

	For soldering		For lead-free soldering	
	Temperature	Time	Temperature	Time
Preheating	140 °C to 180 °C	60 s to 120 s	150 °C to 180 °C	60 s to 120 s
Soldering	245 ± 5 °C	20 s to 30 s	max. 260 °C	max. 10 s

<Repair with hand soldering>

- Preheat with a blast of hot air or similar method. Use a soldering iron with a tip temperature of 350 °C or less. Solder each electrode for 3 seconds or less.
- Never touch this product with the tip of a soldering iron.

⚠ Safety Precautions

The following are precautions for individual products. Please also refer to the common precautions for fuses in this catalog.

1. Set the rated current so that the current passing through the Micro Chip Fuses (hereafter called the fuses) under normal conditions is within 70% of the rated current.
2. Do not continuously pass a current exceeding the rated current through the fuses.
3. If a pulse exceeding the rated current is applied, such as a rush current or surge current at power-on, take care not to cause unwanted fusing. Calculate the I^2t value of the pulse and check the tolerance to the number of pulses according to the I^2t -t characteristic curve before deciding to use the fuses. Before checking the tolerance, consult our sales staff in advance.
4. The fuses are designed to be blown out by a current that is double or greater than the rated current. Ensure that the abnormal current generated when a circuit abnormality occurs in your product is at least double or greater than the rated current of the fuses. In addition, ensure that the abnormal current of your product does not exceed the maximum interrupting current of the fuses.
5. The fuses are designed to be used on the secondary side of a power supply. Do not use them on the primary side.
6. Ensure that the voltage applied to the fuses are within their rated voltage.
7. The fusing characteristics of the fuses are affected by the ambient temperature. Before use, mount the fuses on your products and carefully check and evaluate their category temperature range.

⚠ Safety Precautions (Common precautions for Fuses)

- When using our products, no matter what sort of equipment they might be used for, be sure to make a written agreement on the specifications with us in advance. The design and specifications in this catalog are subject to change without prior notice.
- Do not use the products beyond the specifications described in this catalog.
- This catalog explains the quality and performance of the products as individual components. Before use, check and evaluate its operations when installed in your products.
- Install the following systems for a failsafe design to ensure safety if these products are to be used in equipment where a defect in these products may cause the loss of human life or other significant damage, such as damage to vehicles (automobile, train, vessel), traffic lights, medical equipment, aerospace equipment, electric heating appliances, combustion/gas equipment, rotating equipment, and disaster/crime prevention equipment.
- * Systems equipped with a protection circuit and a protection device
- * Systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault

(1) Precautions for use

- These products are designed and manufactured for general and standard use in general electronic equipment (e.g. AV equipment, home electric appliances, office equipment, information and communication equipment)
- These products are not intended for use in the following special conditions. Before using the products, carefully check the effects on their quality and performance, and determine whether or not they can be used.
 1. In liquid, such as water, oil, chemicals, or organic solvent
 2. In direct sunlight, outdoors, or in severe dust condition
 3. In salty air or air with a high concentration of corrosive gas, such as Cl₂, H₂S, NH₃, SO₂, or NO₂
 4. Electric Static Discharge (ESD) Environment
These components are sensitive to static electricity and can be damaged under static shock (ESD). Please take measures to avoid any of these environments.
Smaller components are more sensitive to ESD environment.
 5. Electromagnetic Environment
Avoid any environment where strong electromagnetic waves exist.
 6. In an environment where these products cause dew condensation
 7. Sealing or coating of these products or a printed circuit board on which these products are mounted, with resin or other materials
- These products generate Joule heat when energized. Carefully position these products so that their heat will not affect the other components (except Thermal Cutoffs).
- Carefully position these products so that their temperatures will not exceed the category temperature range due to the effects of neighboring heat-generating components. Do not mount or place heat-generating components or inflammables, such as vinyl-coated wires, near these products (except Thermal Cutoffs).
- Note that non-cleaning solder, halogen-based highly active flux, or water-soluble flux may deteriorate the performance or reliability of the products.
- Carefully select a flux cleaning agent for use after soldering. An unsuitable agent may deteriorate the performance or reliability. In particular, when using water or a water-soluble cleaning agent, be careful not to leave water residues. Otherwise, the insulation performance may be deteriorated.

(2) Precautions for storage

The performance of these products, including the solderability, is guaranteed for a year from the date of arrival at your company, provided that they remain packed as they were when delivered and stored at a temperature of 5 °C to 35 °C and a relative humidity of 45 % to 85 %.

The performance of Thermal Cutoffs is guaranteed for a year after our delivery, provided that they are stored at a temperature of -10 °C to +40 °C and a relative humidity of 30 % to 75 %.

Even within the above guarantee periods, do not store these products in the following conditions. Otherwise, their electrical performance and/or solderability may be deteriorated, and the packaging materials (e.g. taping materials) may be deformed or deteriorated, resulting in mounting failures.

1. In salty air or in air with a high concentration of corrosive gas, such as Cl₂, H₂S, NH₃, SO₂, or NO₂
2. In direct sunlight

<Package markings>

Package markings include the product number, quantity, and country of origin. In principle, the country of origin should be indicated in English.